

HIGH BANDWIDTH LOW NOISE CROSS-COUPLED AMPLIFIER

BACKGROUND OF THE INVENTION

The present invention relates to a read system for reading information from a magnetic storage medium using a magnetoresistive head and for providing an output signal representative of the information read. In particular, the present invention relates to a read system with improved bandwidth and high frequency noise performance.

A popular method of magnetic data storage utilizes magnetoresistive (MR) heads to store and recover data on a magnetic data storage medium such as a magnetic disk. An MR head employs an MR element that changes in resistivity with changing magnetic flux from data patterns on an adjacent magnetic disk surface. A bias current having a constant value is passed through the MR element, and the change in resistivity is measured by sensing the change in voltage across the MR head.

Amplifier circuits that sense signals from MR heads commonly include differential inputs and differential outputs. While there are a wide variety of differential amplifier circuit topologies, most include an input stage with two load resistors and symmetrical transistors for splitting current between the load resistors. Usually, the output voltage is taken as the difference in the voltage drops across the load resistors; in this manner, large variations in output voltages may be achieved with extremely small input voltage differentials.

For all differential amplifier circuits there are associated therewith certain frequency response performance characteristics. These characteristics and others determine the usefulness of the amplifier circuit in any given application.

The band of frequencies over which the gain of the amplifier circuit is almost constant is called the bandwidth. Signals whose frequencies are outside the bandwidth will experience lower gain, with the gain decreasing as the signals move farther away from the bandwidth. Normally, the amplifier circuit is designed so that its bandwidth coincides with the spectrum of signals it is required to amplify. If this were not the case, the amplifier circuit would distort the frequency spectrum

of the input signal, with different components of the input signal being amplified by different amounts.

One well-known modification to the differential amplifier circuit is the addition of two capacitors that are cross-coupled to the transistors of the input stage. The capacitive (or ac) cross-coupling causes the noise resistances of the input transistors to be connected in parallel instead of in series, thereby reducing the effective noise resistances of the input transistors. An example of such a circuit is shown in U.S. Pat. No. 5,559,646. However, the main disadvantage of this type of circuit is its limited bandwidth. Because the cross-coupled capacitors cause the input capacitances of the input transistors to be connected in parallel, the effective input capacitances of the input transistors are increased. Therefore, because upper cutoff frequency is inversely proportional to input capacitance for transistors, the high frequency bandwidth of the circuit is reduced and the high frequency noise is increased.

Accordingly, there is a need for a differential amplifier circuit having a cross-coupled input stage with improved bandwidth and high frequency noise performance.

BRIEF SUMMARY OF THE INVENTION

The present invention is a differential amplifier circuit for amplifying an input signal and for providing an output signal representative of the input signal. First and second amplifier circuits each include first and second transistors, a resistor, and a current generator. A first coupling circuit includes a transistor, a capacitor, and a current generator, and couples a first input signal node to the first transistor of the second amplifier circuit. A second coupling circuit includes a transistor, a capacitor, and a current generator, and couples a second input signal node to the first transistor of the first amplifier circuit.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 shows a circuit schematic diagram of a read system embodying the present invention.

FIG. 2a shows an equivalent input circuit schematic diagram of a
5 read system embodying the present invention.

FIG. 2b shows a simplified input circuit schematic diagram of a read system embodying the present invention.

FIG. 3 shows a circuit schematic diagram of a prior art read system.

FIG. 4a shows an equivalent input circuit schematic diagram of a
10 prior art read system.

FIG. 4b shows a simplified input circuit schematic diagram of a prior art read system.

FIG. 5 shows a graph comparing the frequency response of a read system embodying the present invention to the frequency response of a prior art
15 read system.

FIG. 6 shows a graph comparing the noise of a read system embodying the present invention to the noise of a prior art read system.

DETAILED DESCRIPTION

20 FIG. 1 shows a circuit schematic diagram of a read system 10 embodying the present invention. Read system 10 includes parallel amplifier circuits 12 and 14, coupling circuits 16 and 18, input signal nodes VMR1 and VMR2, output signal nodes VO1 and VO2, bias voltage VBIAS, and voltage potentials VCC and VEE.

25 Parallel amplifier circuit 12 includes transistors Q1 and Q3, resistor R1, and current generator I1. Transistors Q1 and Q3 are npn bipolar junction transistors each having a base, a collector, and an emitter. The emitter of transistor Q1 is connected to input signal node VMR1, and the collector of transistor Q1 is

connected to the emitter of transistor Q3. The base of transistor Q3 is connected to bias voltage VBIAS, and the collector of transistor Q3 is connected to voltage potential VCC through resistor R1. Current generator I1 is connected between the emitter of transistor Q1 and voltage potential VEE. Output signal node VO1 is

5 connected to the collector of transistor Q3.

Parallel amplifier circuit 14 includes transistors Q2 and Q4, resistor R2, and current generator I2. Transistors Q2 and Q4 are npn bipolar junction transistors each having a base, a collector, and an emitter. The emitter of transistor Q2 is connected to input signal node VMR2, and the collector of transistor Q2 is

10 connected to the emitter of transistor Q4. The base of transistor Q4 is connected to bias voltage VBIAS, and the collector of transistor Q4 is connected to voltage potential VCC through resistor R2. Current generator I2 is connected between the emitter of transistor Q2 and voltage potential VEE. Output signal node VO2 is connected to the collector of transistor Q4.

15 Coupling circuit 16 includes transistor Q5, capacitor C1, and current generator I3. Transistor Q5 is a npn bipolar junction transistor having a base, a collector, and an emitter. The base of transistor Q5 is connected to input signal node VMR2, the collector of transistor Q5 is connected to voltage potential VCC, and the emitter of transistor Q5 is coupled to the base of transistor Q1 through

20 capacitor C1. Current generator I3 is connected between the emitter of transistor Q5 and voltage potential VEE.

Coupling circuit 18 includes transistor Q6, capacitor C2, and current generator I4. Transistor Q6 is a npn bipolar junction transistor having a base, a collector, and an emitter. The base of transistor Q6 is connected to input signal

25 node VMR1, the collector of transistor Q6 is connected to voltage potential VCC, and the emitter of transistor Q6 is coupled to the base of transistor Q2 through capacitor C2. Current generator I4 is connected between the emitter of transistor Q6 and voltage potential VEE.

In operation, the voltage across an MR head is related to the signal that is retrieved from a data pattern on an adjacent magnetic disk surface. This voltage across the MR head is represented in FIG. 1 at input signal nodes VMR1 and VMR2. The voltage difference between input signal nodes VMR1 and VMR2 is the input signal that is sensed by read system 10. Variations in the voltage difference between input signal nodes VMR1 and VMR2 lead to variations in the currents through parallel amplifier circuits 12 and 14, due to the constant values of resistors R1 and R2. These variations in currents lead to voltage variations across resistors R1 and R2, which in turn lead to variations in the voltage difference between output signal nodes VO1 and VO2.

Transistor Q3 and resistor R1 form a collector circuit, as do transistor Q4 and resistor R2. Transistors Q3 and Q4 form a differential common-base stage, otherwise known as a cascode stage. The load resistance seen by transistor Q1 is not resistor R1 but is the much lower input resistance of transistor Q3. Similarly, the load resistance seen by transistor Q2 is not resistor R2 but is the much lower input resistance of transistor Q4. Because load resistance is inversely proportional to upper cutoff frequency for bipolar junction transistors, these reductions in the effective load resistances of transistors Q1 and Q2 lead to a considerable improvement in the amplifier circuit frequency response.

Transistors Q5 and Q6 are the most important features of the present invention. By coupling input signal node VMR2 to the base of transistor Q1 using both transistor Q5 and capacitor C1, the input capacitance of transistor Q1 is reduced compared to using a capacitor alone. This is because transistor Q5 is connected as an emitter follower and provides an emitter-base capacitance that, when connected in series with capacitor C1, reduces the net capacitance between input signal node VMR2 and transistor Q1. Similarly, by coupling input signal node VMR1 to the base of transistor Q2 using both transistor Q6 and capacitor C2, the input capacitance of transistor Q2 is reduced compared to using a capacitor

alone. This is because transistor Q6 is connected as an emitter follower and provides an emitter-base capacitance that, when connected in series with capacitor C2, reduces the net capacitance between input signal node VMR1 and transistor Q2. Because input capacitance is inversely proportional to upper cutoff frequency for bipolar junction transistors, these reductions in the effective input capacitances of transistors Q1 and Q2 lead to a higher upper cutoff frequency and thus a considerable increase in the bandwidth of the input stage, which in turn decreases high frequency noise.

When analyzing transistor circuits, small-signal equivalent circuit models are often used to express the components of the transistors in terms of model parameters. In this way, it is possible to understand the signal operation of the transistors, and reduce the circuit to an equivalent circuit model consisting of more basic circuit elements. Model parameters which are useful in analyzing the effects of coupling circuits 16 and 18 of read system 10 include both the base-emitter input resistances and the base-emitter capacitances of transistors Q1, Q2, Q5, and Q6. The small-signal input resistance between the base and the emitter of a bipolar junction transistor, looking into the base, is denoted by R_{pi} . The emitter-base capacitance of a bipolar junction transistor is denoted by C_{pi} .

FIG. 2a shows an equivalent input circuit schematic diagram of read system 10. Equivalent input circuit 20 includes input signal nodes VMR1 and VMR2, capacitors CC1, CC2, C_{pi1} , C_{pi2} , C_{pi5} , and C_{pi6} , and resistors R_{pi1} , R_{pi2} , R_{pi5} , and R_{pi6} . Capacitor C_{pi1} and resistor R_{pi1} (parameters representing transistor Q1) are connected in parallel between input signal node VMR1 and capacitor CC1 (parameter representing capacitor C1). Capacitor C_{pi6} and resistor R_{pi6} (parameters representing transistor Q6) are connected in parallel between input signal node VMR1 and capacitor CC2 (parameter representing capacitor C2). Capacitor C_{pi2} and resistor R_{pi2} (parameters representing transistor Q2) are connected in parallel between input signal node VMR2 and capacitor CC2.

Capacitor Cpi5 and resistor Rpi5 (parameters representing transistor Q5) are connected in parallel between input signal node VMR2 and capacitor CC1. The value of capacitors CC1 and CC2 each greatly exceed the value of capacitors Cpi1, Cpi2, Cpi5, and Cpi6.

- 5 FIG. 2b shows a simplified input circuit schematic diagram of read system 10. Simplified input circuit 22 is a reduced form of equivalent input circuit 20. Capacitors CC1, CC2, Cpi1, Cpi2, Cpi5, and Cpi6 of equivalent input circuit 20 can all be reduced to a single effective capacitance Ceff. This is because capacitors connected in series can be replaced by a single equivalent capacitor, which is related to the individual capacitors by the formula

$$\frac{1}{C_{eq}} = \frac{1}{C_1} + \frac{1}{C_2} + \cdots + \frac{1}{C_n}$$

- And capacitors connected in parallel can be replaced by a single equivalent capacitor which is equal to the sum of the individual capacitors. Similarly, resistors Rpi1, Rpi2, Rpi5, and Rpi6 of equivalent input circuit 20 can all be reduced to a single effective resistance Reff. This is because resistors connected in series can be replaced by a single equivalent resistor which is equal to the sum of the individual resistors. And resistors connected in parallel can be replaced by a single equivalent resistor, which is related to the individual resistors by the formula

$$\frac{1}{R_{eq}} = \frac{1}{R_1} + \frac{1}{R_2} + \cdots + \frac{1}{R_n}$$

- 20 Simplified input circuit 22 includes input signal nodes VMR1 and VMR2, capacitor Ceff, and resistor Reff. Capacitor Ceff and resistor Reff are connected in parallel between input signal nodes VMR1 and VMR2. The value of capacitor Ceff is equal to $3(C_{pi1})/2$, where capacitor Cpi1 is from equivalent input circuit 20. The value of resistor Reff is equal to the value of Re in parallel with the value of Rpi1, which is approximately Re (the value of Rpi1 greatly exceeds the value of Re), where
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resistor R_e is the small-signal base-emitter input resistance of transistor Q1 looking into the emitter, and resistor R_{pi1} is from equivalent input circuit 20.

In order to appreciate the improvements of the present invention, the input capacitance, bandwidth, and noise of read system 10 are compared to the same characteristics of a prior art read system shown in FIG. 3.

FIG. 3 shows a circuit schematic diagram of a prior art read system 30. Prior art read system 30 is similar to read system 10 with the exception that transistors Q5 and Q6, and current generators I3 and I4 are not present. Instead, capacitor C1 is directly connected between input signal node VMR2 and the base of transistor Q1, and capacitor C2 is directly connected between input signal node VMR1 and the base of transistor Q2. Due to the lack of additional emitter-base capacitances between the input signal nodes and the input transistors, prior art read system 30 lacks the reduced input capacitance caused by the emitter-base capacitances of transistors Q5 and Q6 in read system 10. Because input capacitance is inversely proportional to upper cutoff frequency for bipolar junction transistors, prior art read system 30 possesses a more limited high frequency bandwidth than read system 10, and therefore exhibits greater high frequency noise than read system 10.

FIG. 4a shows an equivalent input circuit schematic diagram of prior art read system 30. Equivalent input circuit 40 includes input signal nodes VMR1 and VMR2, capacitors CC1, CC2, Cpi1, and Cpi2, and resistors Rpi1 and Rpi2. Capacitor Cpi1 and resistor Rpi1 (parameters representing transistor Q1) are connected in parallel between input signal node VMR1 and capacitor CC1 (parameter representing capacitor C1), and capacitor CC1 is connected to input signal node VMR2. Capacitor Cpi2 and resistor Rpi2 (parameters representing transistor Q2) are connected in parallel between input signal node VMR2 and capacitor CC2 (parameter representing capacitor C2), and capacitor CC2 is

connected to input signal node VMR1. The value of capacitors CC1 and CC2 each greatly exceed the value of capacitors Cpi1 and Cpi2.

FIG. 4b shows a simplified input circuit schematic diagram of prior art read system 30. Simplified input circuit 42 is a reduced form of equivalent input circuit 40. For similar reasons discussed above, capacitors CC1, CC2, Cpi1, and Cpi2 of equivalent input circuit 40 can all be reduced to a single effective capacitance Ceff, and resistors Rpi1 and Rpi2 of equivalent input circuit 40 can be reduced to a single effective resistance Reff. Simplified input circuit 42 includes input signal nodes VMR1 and VMR2, capacitor Ceff, and resistor Reff. Capacitor Ceff and resistor Reff are connected in parallel between input signal nodes VMR1 and VMR2. The value of capacitor Ceff is equal to $2(C_{pi1})$, where capacitor Cpi1 is from equivalent input circuit 40. The value of resistor Reff is equal to the value of Re in parallel with the value of Rpi1, which is approximately Re (the value of Rpi1 greatly exceeds the value of Re), where resistor Re is the small-signal base-emitter input resistance of transistor Q1 looking into the emitter, and resistor Rpi1 is from equivalent input circuit 40.

Comparing simplified input circuit 22 of the present invention to simplified input circuit 42 according to the prior art, it can be seen that the value of capacitor Ceff of simplified input circuit 42 is approximately 33% greater than the value of Ceff of simplified input circuit 22. Therefore, the input capacitance of prior art read system 30 is approximately 33% greater than the input capacitance of read system 10.

FIG. 5 shows a graph comparing the frequency response 50 of read system 10 to the frequency response 52 of prior art read system 30. The graph shows the gain (dB) as a function of frequency (Hz). The band of frequencies over which the gain is almost constant, to within a certain number of decibels, is called the bandwidth. The bandwidth of read system 10 extends approximately from $2 \cdot 10^6 \text{ Hz}$ to $2 \cdot 10^9 \text{ Hz}$. The bandwidth of prior art read system 30 extends

approximately from 2×10^6 Hz to 1×10^9 Hz. Therefore, the bandwidth of read system 10 extends approximately 1×10^9 Hz further than the bandwidth of prior art read system 30.

FIG. 6 shows a graph comparing the input referred noise 60 of read system 10 to the input referred noise 62 of prior art read system 30. The graph shows the noise (10^{-9} V) as a function of frequency (Hz). The range of frequencies over which read system 10 exhibits noise less than 1.0×10^{-9} V extends approximately from 1.6×10^7 Hz to 1.2×10^9 Hz. The range of frequencies over which prior art read system 30 exhibits noise less than 1.0×10^{-9} V extends approximately from 1.6×10^7 Hz to 6×10^8 Hz. Therefore, the range of frequencies over which read system 10 exhibits less than 1.0×10^{-9} V of noise extends approximately 4.2×10^8 Hz further than the range of frequencies over which prior art read system 30 exhibits less than 1.0×10^{-9} V of noise.

Therefore, the present invention provides a read system having a cross-coupled input stage with improved bandwidth and high frequency noise performance. By implementing coupling circuits with both emitter followers and capacitors, the read system allows a reduced net capacitance between the input signal nodes and the input transistors. The reduced effective input capacitances extend the upper cutoff frequencies of the input transistors, and increase the bandwidth of the read system. This results in reduced high frequency noise, and greater accuracy and capability in detecting data recorded on a magnetic disk with an MR head.

Although the preferred embodiment of the present invention is shown using npn bipolar technology, the present invention may also be practiced using pnp bipolar and FET technologies, the topology for either being readily derived from the small-signal models associated with the npn embodiment. Furthermore, the present invention may be practiced using either discrete or integrated circuit designs. Workers skilled in the art will recognize that changes

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